	connecto	rs
	SPECIFICATIO	N
宏到	收電子股份有[限公司
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	TEL: +886-3-463-2808 FAX: +886-3-463-1800	
SPEC. NO.: PS-525	615-XXXXX-XXX RE	CVISION: A
PRODUCT NAME:	0.5 mm PITCH EASY ON FPC	/FFC CONN.
	SMT R/A B/C TYPE	
PRODUCT NO:	52515 SERIES	
PREPARED:	CHECKED:	APPROVED:
ZHUWEI	BRAVE	BRAVE
DATE: 2019/03/05	DATE: 2019/03/05	DATE: 2019/03/05

	es e	Aces I	P/N: 52515 series	
TITLE:	FPC 0.5 PITCH	EASY ON FPC CO	NN	
RELEASE	DATE: 2019/03/05	REVISION: A	ECN No: ECN-1903044	PAGE: 2 OF 11
1 2 3 4 5 6 7 8	SCOPE APPLICABLE DO REQUIREMENT PERFORMANCE INFRARED REF	DCUMENTS S E LOW CONDITION . LIFICATION AND T	EST SEQUENCE	

Connectors	Aces P/N:	52515 series	
TITLE: FPC 0.5 PITCH	EASY ON FPC CONN		
RELEASE DATE: 2019/03/05	REVISION: A	ECN No: ECN-1903044	PAGE: 3 OF 11

1 Revision History

Rev.	ECN # Revision Description		Prepared	Date
Α	ECN-1903044	ECN-1903044 FOR APD1080051 NEW DRAWING		2019/03/05

	Aces P/N: 52515 series
Т	ITLE: FPC 0.5 PITCH EASY ON FPC CONN
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2	SCOPE
	This specification covers performance, tests and quality requirements for 0.5mm pitch FPC SMT R/A Easy on connector.
3	APPLICABLE DOCUMENTS
	EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION
4	REQUIREMENTS
	4.1 Design and Construction
	4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
	4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
	4.2 Materials and Finish
	 4.2.1 Contact: High performance copper alloy (Phosphor Bronze) Finish: (a) Contact Area: Refer to the drawing. (b) Under plate: Refer to the drawing. (c) Solder area: Refer to the drawing.
	4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0
	4.2.3 Actuator: Thermoplastic or Thermoplastic High Temp., UL94V-04.2.4 Fitting Nail: Copper Alloy, Finish: Refer to the drawing.
	4.3 Ratings
	4.3.1 Working voltage less than 36 volts AC (per pin)
	 4.3.2 Voltage: 50 Volts AC (per pin) 4.3.3 Current: 0.5 Amperes (per pin) 4.3.4 Operating Temperature : -40°C to +85°C
	Page 4 2010/10/31 TR-FM-73015L

Connectors		Aces P/N: 5	2515 series	
TITLE: FPC 0.5 PITCH I	EASY ON FP	C CONN		
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5 Performance

5.1. Test Requirements and Procedures Summary

ltem	Requirement	Standard
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.
	ELECTRICAL	
ltem	Requirement	Standard
Low Level Contact Resistance	50 m Ω Max. (initial)per contact 20 m Ω Max. change allowed	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)
Insulation Resistance	500 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	300 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature Rise	30℃ Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70, METHOD1,CONDITION1)

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	MECHANICAL Item Deguingment						
Item	Requirement	Standard					
Durability	30 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min. (EIA-364-09) A connector shall be soldered on a					
FPC Retention Force	30gf/PIN MIN.	A connector shall be soldered on a board and insert the actuator, pull the FPC at the speed rate of 25.4 ± 3 mm/min.					
Terminal / Housing Retention Force	100 gf MIN.	Operation Speed : 25.4 ± 3 mm/minute. Measure the contact retention force with tester.					
Fitting Nail /Housing Retention Force	100 gf MIN.	Operation Speed : 25.4 ± 3 mm/minute. Measure the contact retention force with tester.					
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)					
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)					

Aces P/N: 52515 series

TITLE: FPC 0.5 PITCH EASY ON FPC CONN

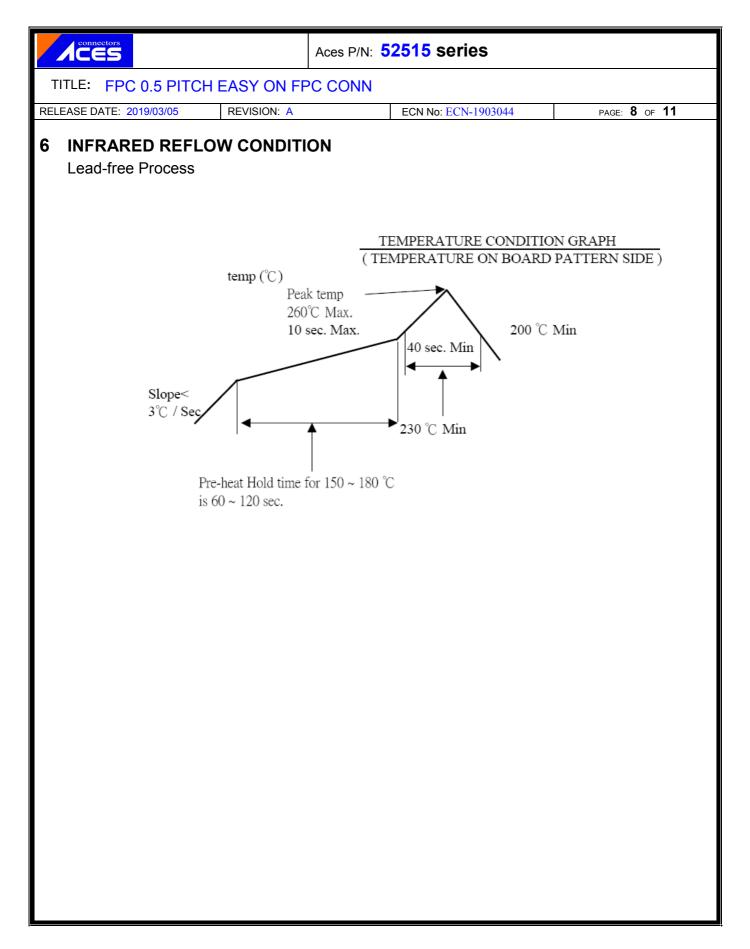
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	ENVIRONMENTAL		
ltem	Requirement	Standard	
Resistance to Reflow Soldering Heat	See Product Qualification and Test Pre Heat : 150°C ~180°C, 60~120sec. Sequence Group 10 (Lead Free) Heat : 230°C Min., 40sec M Peak Temp. : 260°C Max, 10sec Max. Reflow number cycle: 2 time (EIA-364-56) Ince Appearance: No damage T ≥ 350°C, 5sec at least. See Product Qualification and Test Mate module and subject to condition for 5 cycles. See Product Qualification and Test See Product Qualification and Test See Product Qualification and Test Adt emodule and subject to condition for 5 cycles. See Product Qualification and Test See Product Qualification and Test See Product Qualification and Test Mated Connector See Product Qualification and Test Mated Connector See Product Qualification and Test Subject mated connectors to %0°C, 90~95% RH, 96 hours. See Product Qualification and Test Subject mated connectors to for sequence Group 5 See Product Qualification and Test Subject mated connectors to for sequence for p 5 See Product Qualification and Test Subject mated/unmated connectors to 5% salt-soluti See Product Qualification and Test Subject mated/unmated See Product Qualification and Test Subject mated/unmated See Product Qualification and Test Subject mated/unmated	60~120sec. Heat : 230℃ Min., 40sec Min. Peak Temp. : 260℃Max, 10sec Max. Reflow number cycle: 2 times	
Hand Soldering Temperature Resistance	Appearance: No damage	T≧350°C, 5sec at least.	
Thermal Shock	See Product Qualification and Test	1 cycles: -40 +0/-3 ℃, 30 minutes +85 +3/-0 ℃, 30 minutes (EIA-364-32, test condition I)	
Humidity	See Product Qualification and Test	(EIA-364-32, test condition I) Mated Connector 40°C, 90~95% RH, 96 hours. (EIA-364-31,Condition A, Method II)	
Temperature life	rature life See Product Qualification and Test temperature life at 85°C f Sequence Group 5 (EIA-364-17, Test conditi Subject mated/unmated connectors to 5% salt-so pray See Product Qualification and Test concentration, 35°C		
Salt Spray (Only For Gold Plating)			
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)	
Resistance to Wave Soldering Heat	See Product Qualification and Test Sequence Group 10 (Lead Free)	Solder Temp. ∶ 265±5℃, 10±0.5sec.	

Note. Flowing Mixed Gas shell be conduct by customer request.



	Aces P	י/N: <mark>5</mark>	2515	ser	ies					
ITLE: FPC 0.5 PITCH EASY ON FP	100 D'	٧N								
EASE DATE: 2019/03/05 REVISION: A			ECN I	No: EC	N-190304	44		PA	GE: 9	OF 11
PRODUCT QUALIFICATION AN		ST S	EQU	ENC	;E					
					Test G	Group				
Test or Examination	1	2	3	4	5	6	7	8	9	10
		<u> </u>		T	est Sec	quenc	;e	<u> </u>	<u>I</u>	<u> </u>
Examination of Product	1、3	1 • 8	1 • 7	1、6	1、4				1	
Low Level Contact Resistance		2、11	2、10	2、9	2 \ 5				3	1、4
Insulation Resistance		3、10	3、9	3 \ 8						
Dielectric Withstanding Voltage		4 \ 9	4 • 8	4 \ 7						
Temperature rise	2									
Durability		6								
Vibration										2
Shock (Mechanical)										3
Thermal Shock			5							
Humidity			6							
Temperature life				5						
Salt Spray					3					
Solder ability						1				
FPC Retention Force		5 \ 7		 						
Terminal / Housing Retention Force							1			
Fitting Nail /Housing Retention Force				 				1		
Resistance to Soldering Heat									2	
Sample Size	2	4	4	4	4	2	4	4	4	4

